AMENDMENTS TO THE SPECIFICATION

Please **AMEND** the specification as shown in the following "marked-up" paragraph, which shows changes made relative to the immediate prior version.

Please AMEND the paragraph beginning on page 8, line 20, as follows.

"Next, the substrate 110 is transported from the sealant-applying unit 3000 to the sealant heat-treating unit 4000 by the in-line conveying unit 1130. It is preferable that a reaction prevention layer is formed on a surface of the sealant 150 through an exposure or heat-treating process such that no reaction takes place between the liquid crystal layer 130 and the sealant 150. For this purpose, it is preferable that an <u>ultraviolet infrared</u> ray-hardening material is used for the sealant 150. During a first hardening process, the sealant 150, with reference to FIG. 6A, is divided into a portion 155 that is hardened and is comprised of the reaction prevention layer, and a portion 157 that has not been hardened."

AMENDMENTS TO THE DRAWINGS

Attached hereto are replacement figure sheet for Fig. 9A and 9B, which include the changes, without marking, identified below.

Fig. 9B has been amended to replace the Korean characters with -- Pumping--.